



TO-220F-B Plastic-Encapsulate Diode

MURF1060CT HYPERFAST RECTIFIER,FRED

MAIN CHARACTERISTICS

I_o	10(5×2)A
V_{RRM}	600V
T_{rr}	18ns
T_j	150℃
$V_{F(typ)}$	1.3V(@$T_j=125℃$)

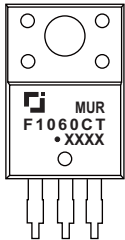
FEATURES

- Ultrafast Recovery Times and Low Recovery Loss
- Low Forward Voltage
- Low Reverse Leakage Current

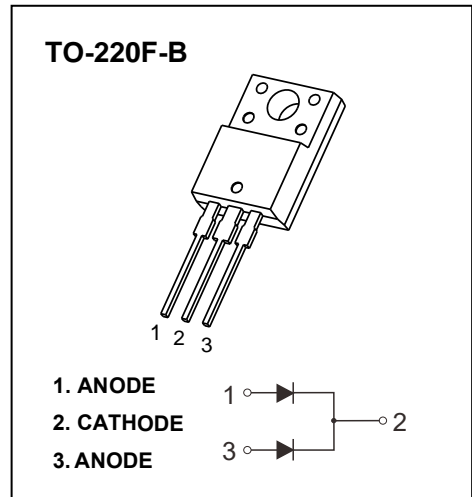
APPLICATIONS

Specifically designed to improve efficiency of PFC and output rectification stages of EV / HEV battery charging stations, booster stage of solar inverters and UPS applications, these devices are perfectly matched to operate with MOSFETs or high speed IGBTs.

MARKING



MURF1060CT = Device code
 Solid dot = Green molding compound device
 if none, the normal device
 XXXX = Code



MAXIMUM RATINGS ($T_c=25℃$ unless otherwise noted)

Symbol	Parameter	MURF1060CT	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V_R	DC Blocking Voltage		
$I_{F(AV)}$	Average rectified output current@ Per leg($T_c=127℃$)	5	A
	Average rectified output current@ Total device($T_c=127℃$)	10	
$I_{F(RMS)}$	RMS Forward Current($T_c=127℃$)	7	A
I_{FSM}	Non-Repetitive Surge Forward Current (8.3ms)	72	A
P_D	Power dissipation	33	W
$R_{\theta JC}$	Thermal Resistance From Junction to Case	3.8	℃/W
T_j	Operating Junction Temperature Range	-55 ~ +150	℃
T_{stg}	Storage Temperature Range	-55 ~ +150	℃

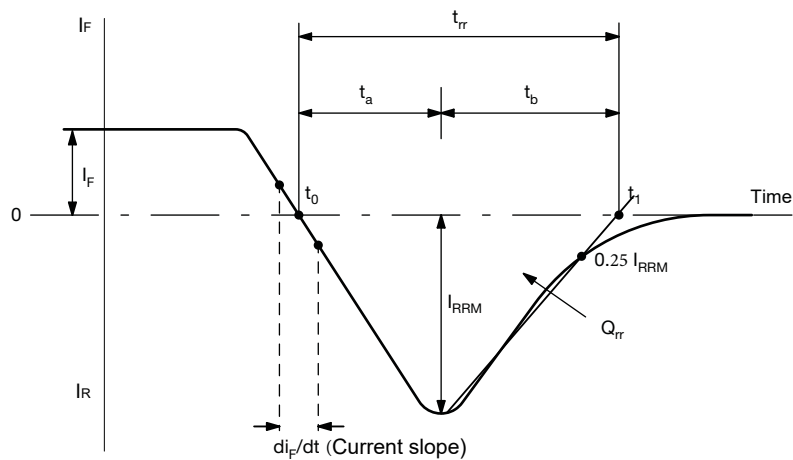
Typical Characteristics

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)}$	Reverse Voltage	$I_R=100\mu\text{A}$	600			V
I_R	Reverse Current	$V_R=600\text{V}$	$T_j=25^\circ\text{C}$		2	μA
			$T_j=125^\circ\text{C}$		500	μA
V_F	Forward Voltage	$I_F=5\text{A}$	$T_j=25^\circ\text{C}$	1.4	1.6	V
			$T_j=125^\circ\text{C}$	1.3		V
C_{tot}	Total Capacitance	$V_R=200\text{V}, f=1\text{MHz}$		3.5		pF
t_{rr}	Reverse Recovery time	$I_F=0.5\text{A}, I_R=1\text{A}, I_{rr}=0.25\text{A}$		24		ns
		$I_F=1\text{A}, V_R=30\text{V}, di_F/dt = 200\text{A}/\mu\text{s}$		18		ns

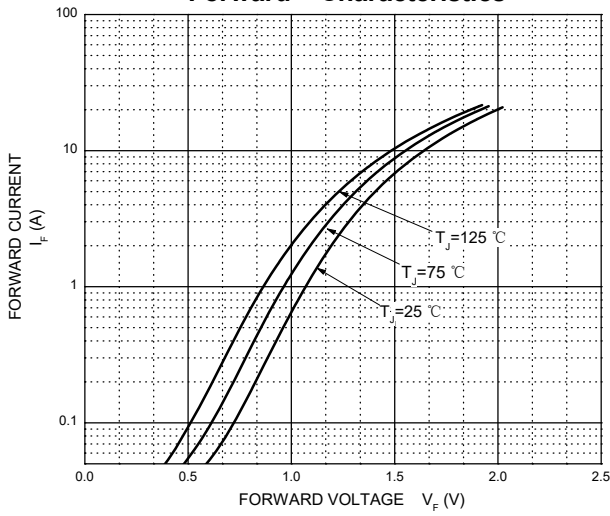
ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse Recovery Time	$I_F=10\text{A}, V_R=400\text{V}, di_F/dt=200\text{A}/\mu\text{s}$		86		ns
I_{RRM}	Max. Reverse Recovery Current			4		A
Q_{rr}	Reverse Recovery Charge			196		nC
t_{rr}	Reverse Recovery Time	$I_F=10\text{A}, V_R=400\text{V}, di_F/dt=200\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		114		ns
I_{RRM}	Max. Reverse Recovery Current			6		A
Q_{rr}	Reverse Recovery Charge			398		nC
t_{rr}	Reverse Recovery Time	$I_F=10\text{A}, V_R=400\text{V}, di_F/dt=600\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		71		ns
I_{RRM}	Max. Reverse Recovery Current			12		A
Q_{rr}	Reverse Recovery Charge			546		nC

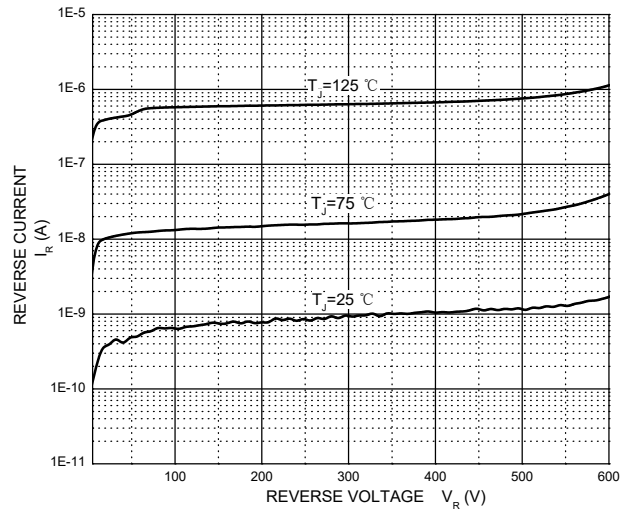


Reverse Recovery Waveform and Definitions

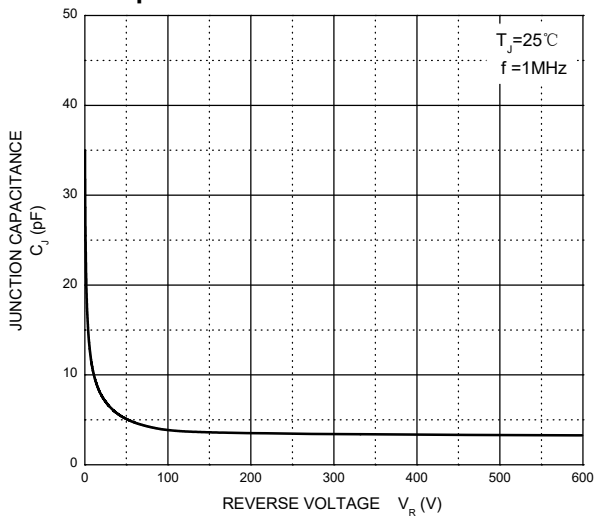
Forward Characteristics



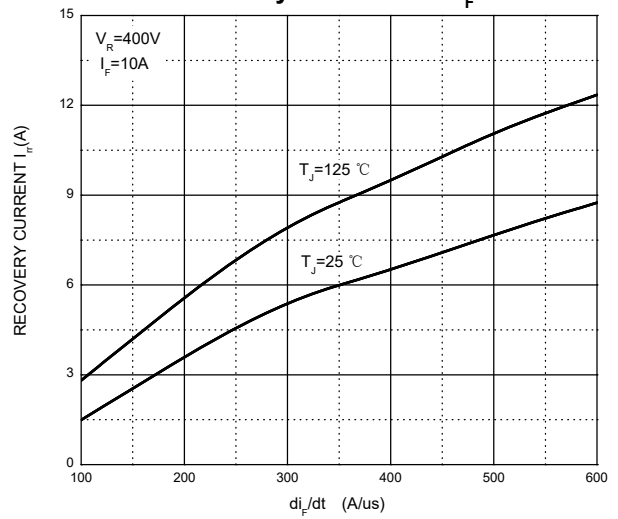
Reverse Characteristics



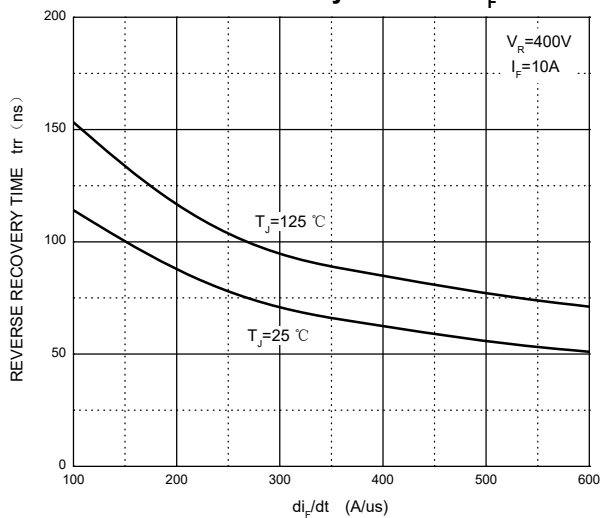
Capacitance Characteristics Per Diode



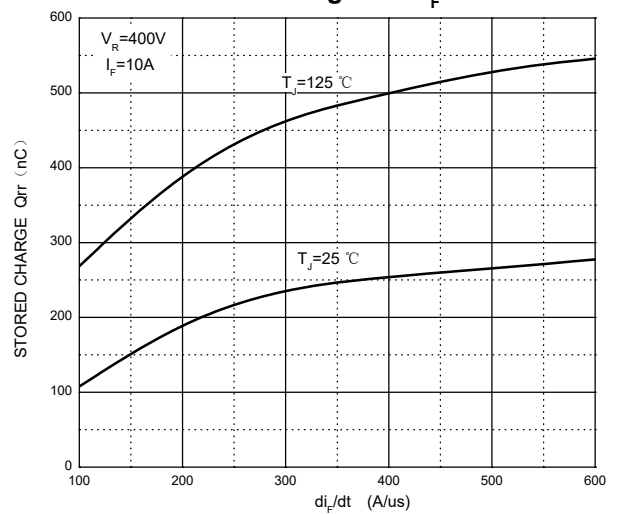
Recovery Current vs. di_F/dt



Reverse Recovery Time vs. di_F/dt

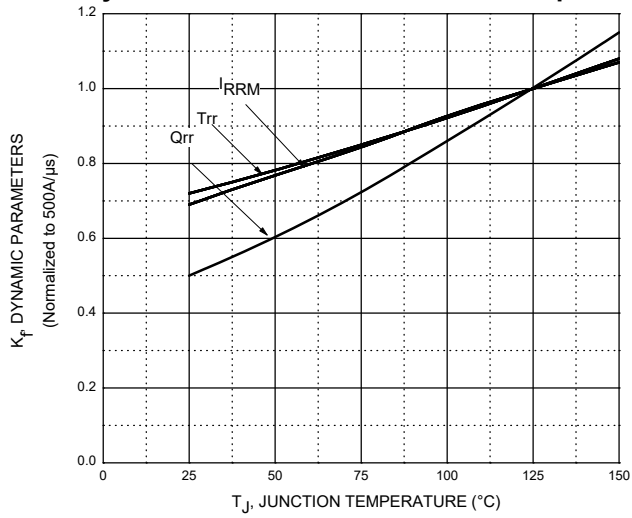


Stored Charge vs. di_F/dt

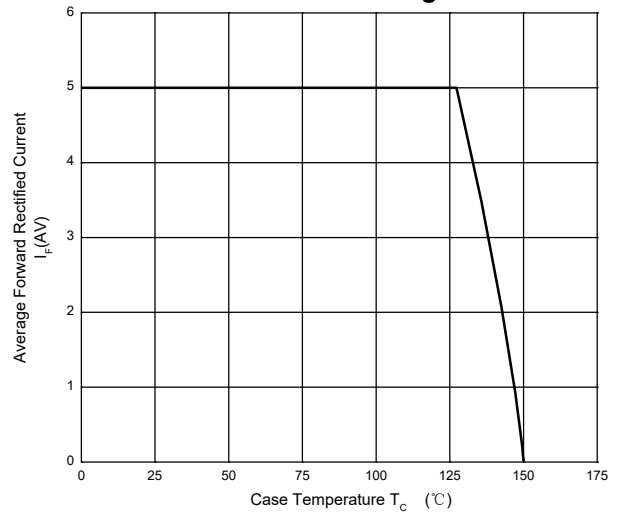


Typical Characteristics

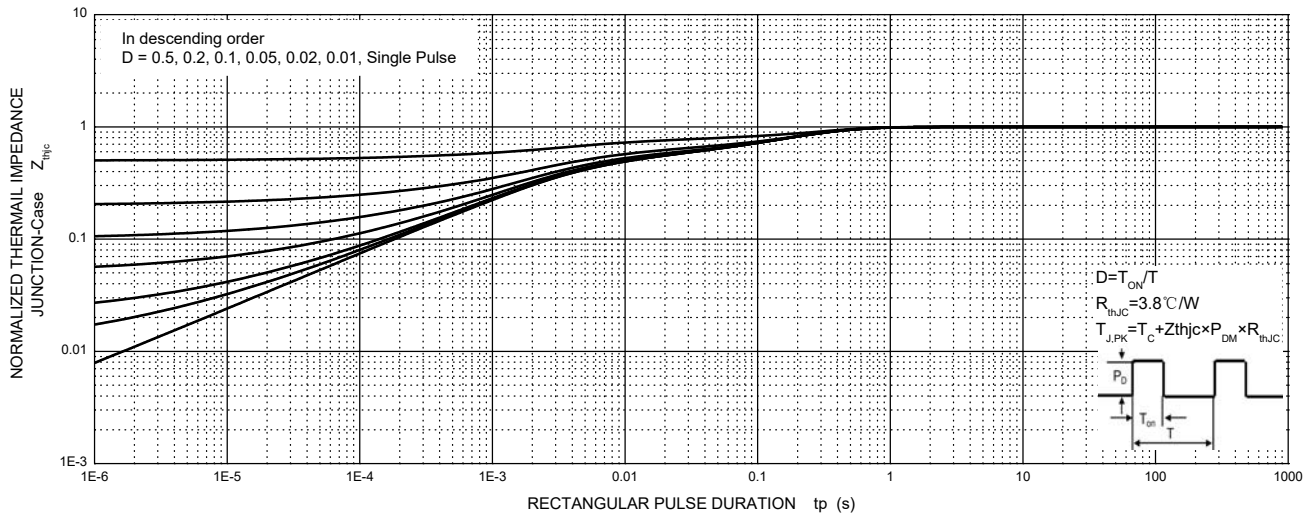
Dynamic Parameters vs. Junction Temperature



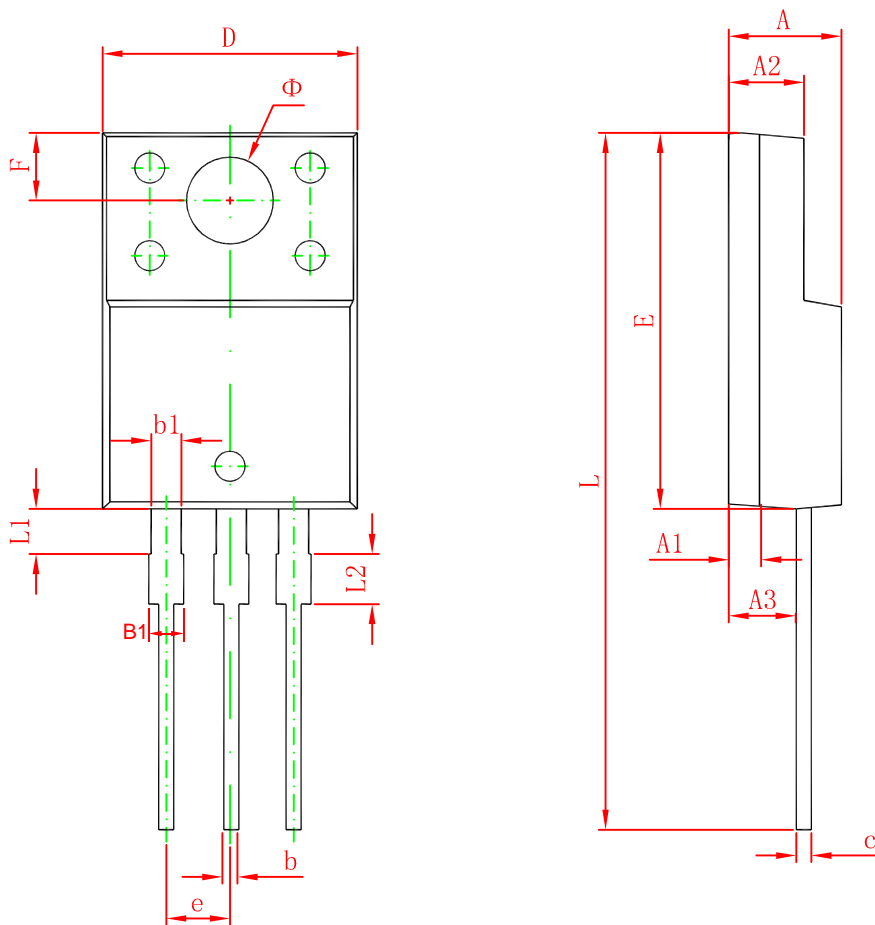
Current Derating



MURF1060CT Transient Thermal Impedance, Junction-Case



TO-220F-B Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.200 REF.		0.047 REF.	
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.710	0.910	0.028	0.036
b1	1.100	1.350	0.043	0.053
B1	1.150	1.400	0.045	0.055
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
Φ	3.300	3.700	0.130	0.146
L	28.000	28.400	1.102	1.118
L1	2.100	2.400	0.082	0.094
L2	1.300	1.700	0.051	0.066